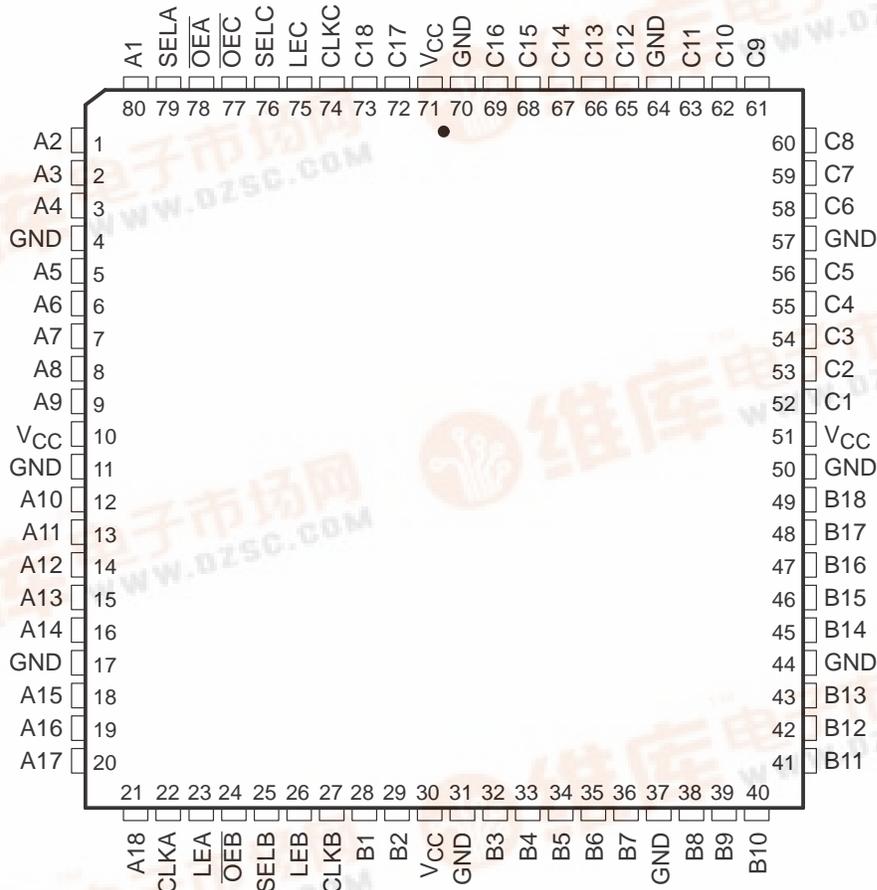


# SN54ABTH32318, SN74ABTH32318 18-BIT TRI-PORT UNIVERSAL BUS EXCHANGERS

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- **Members of the Texas Instruments Widebus+™ Family**
- **State-of-the-Art EPIC-II<sup>™</sup> BiCMOS Design Significantly Reduces Power Dissipation**
- **UBE™ (Universal Bus Exchanger) Combines D-Type Latches and D-Type Flip-Flops for Operation in Transparent, Latched, or Clocked Mode**
- **Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17**
- **Typical V<sub>OLP</sub> (Output Ground Bounce) < 0.8 V at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C**
- **High-Impedance State During Power Up and Power Down**
- **Distributed V<sub>CC</sub> and GND Pin Configuration Minimizes High-Speed Switching Noise**
- **High-Drive Outputs (–32-mA I<sub>OH</sub>, 64-mA I<sub>OL</sub>)**
- **Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors**
- **Package Options Include 80-Pin Plastic Thin Quad Flat (PN) Package With 12 × 12-mm Body Using 0.5-mm Lead Pitch and 84-Pin Ceramic Quad Flat (HT) Package**

SN74ABTH32318 . . . PN PACKAGE  
(TOP VIEW)



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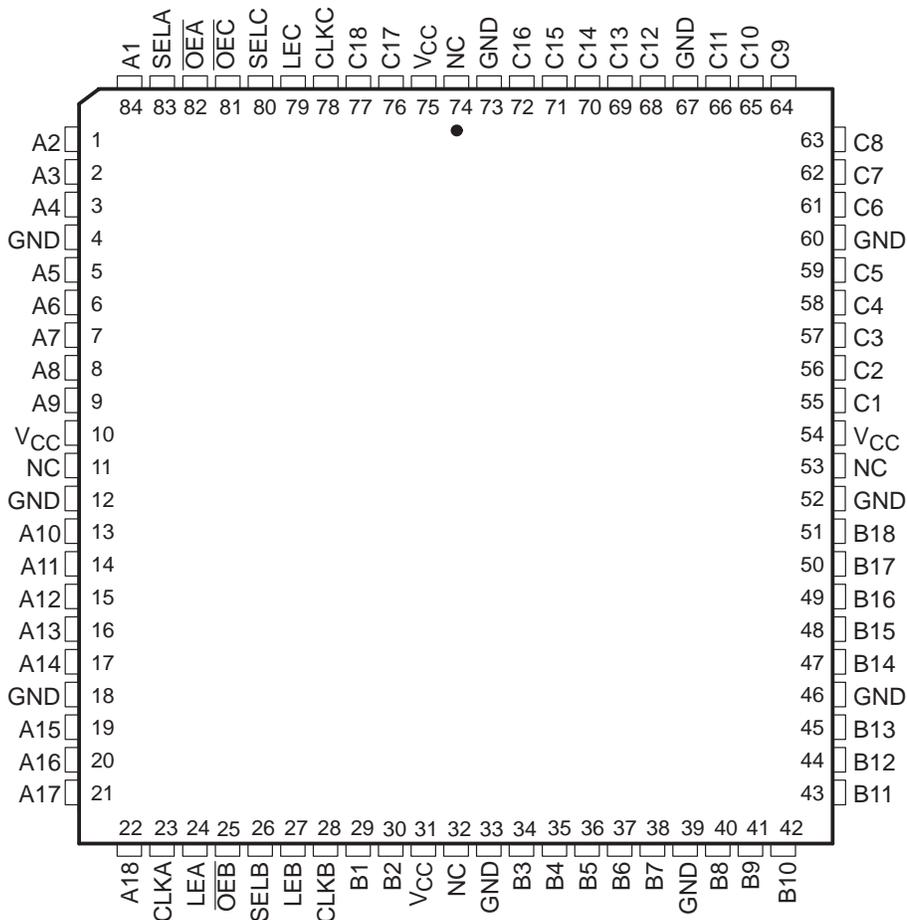
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# SN54ABTH32318, SN74ABTH32318 18-BIT TRI-PORT UNIVERSAL BUS EXCHANGERS

SCBS180E – JUNE 1992 – REVISED MAY 1997

SN54ABTH32318 . . . HT PACKAGE  
(TOP VIEW)



NC – No internal connection

## description

The 'ABTH32318 consist of three 18-bit registered input/output (I/O) ports. These registers combine D-type latches and flip-flops to allow data flow in transparent, latch, and clock modes. Data from one input port can be exchanged to one or more of the other ports. Because of the universal storage element, multiple combinations of real-time and stored data can be exchanged among the three ports.

Data flow in each direction is controlled by the output-enable ( $\overline{OEA}$ ,  $\overline{OEB}$ , and  $\overline{OEC}$ ), select-control (SELA, SELB, and SELC), latch-enable (LEA, LEB, and LEC), and clock (CLKA, CLKB, and CLKC) inputs. The A data register operates in the transparent mode when LEA is high. When LEA is low, data is latched if CLKA is held at a high or low logic level. If LEA is low, data is stored on the low-to-high transition of CLKA. Output data selection is accomplished by the select-control pins. All three ports have active-low output enables, so when the output-enable input is low, the outputs are active; when the output-enable input is high, the outputs are in the high-impedance state.

When  $V_{CC}$  is between 0 and 2.1 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 2.1 V,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

# SN54ABTH32318, SN74ABTH32318 18-BIT TRI-PORT UNIVERSAL BUS EXCHANGERS

SCBS180E – JUNE 1992 – REVISED MAY 1997

## description (continued)

The SN54ABTH32318 is characterized for operation over the full military temperature range of  $-55^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ . The SN74ABTH32318 is characterized for operation from  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ .

### Function Tables

#### STORAGE<sup>†</sup>

INPUTS			OUTPUT
CLKA	LEA	A	
↑	L	L	L
↑	L	H	H
H	L	X	$Q_0^{\ddagger}$
L	L	X	$Q_0^{\ddagger}$
X	H	L	L
X	H	H	H

<sup>†</sup> A-port register shown. B and C ports are similar but use CLKB, CLKC, LEB, and LEC.

<sup>‡</sup> Output level before the indicated steady-state input conditions were established

#### A-PORT OUTPUT

INPUTS		OUTPUT A
$\overline{\text{OEA}}$	SELA	
H	X	Z
L	H	Output of C register
L	L	Output of B register

#### B-PORT OUTPUT

INPUTS		OUTPUT B
$\overline{\text{OEB}}$	SELB	
H	X	Z
L	H	Output of A register
L	L	Output of C register

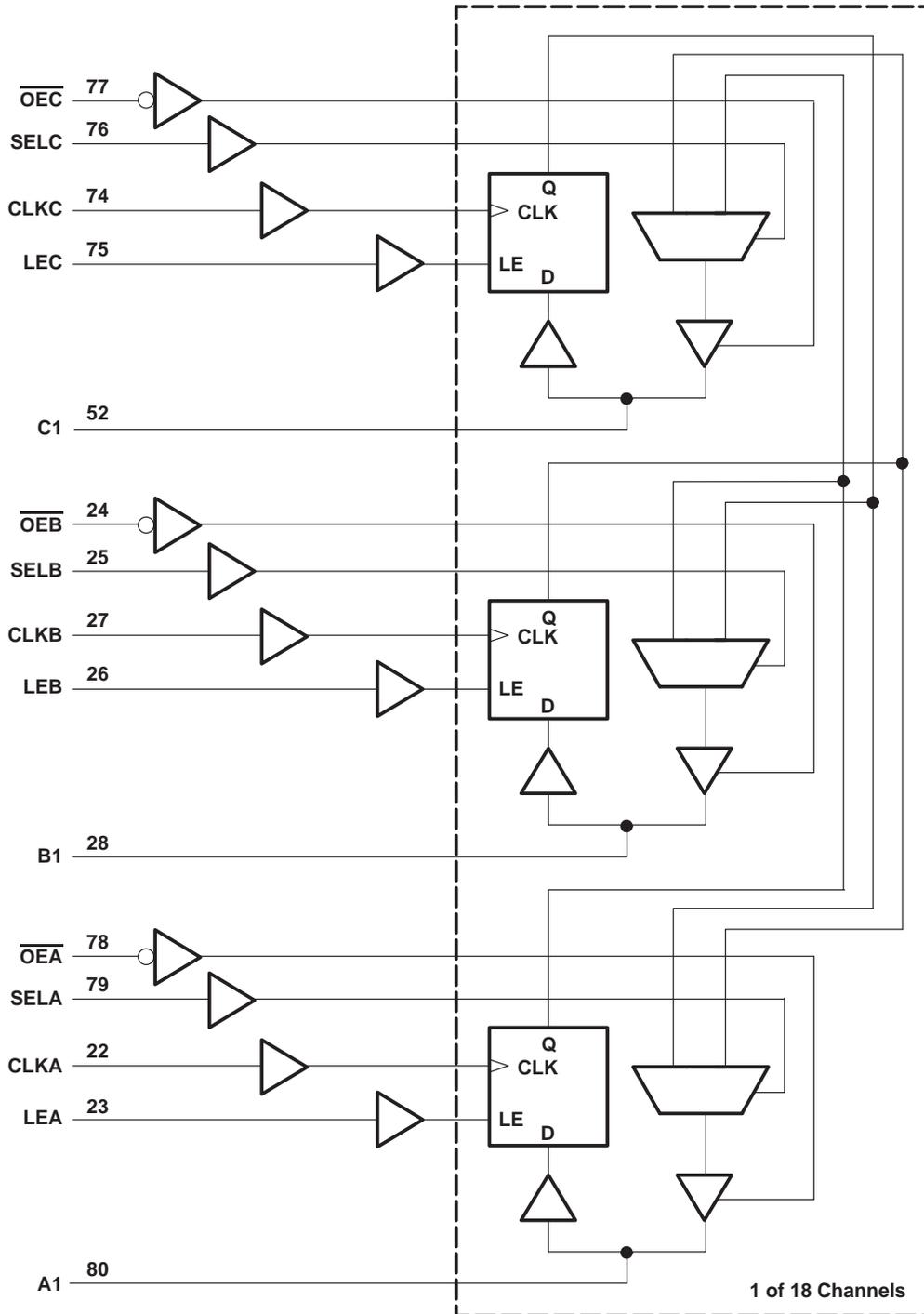
#### C-PORT OUTPUT

INPUTS		OUTPUT C
$\overline{\text{OEC}}$	SELC	
H	X	Z
L	H	Output of B register
L	L	Output of A register

# SN54ABTH32318, SN74ABTH32318 18-BIT TRI-PORT UNIVERSAL BUS EXCHANGERS

SCBS180E – JUNE 1992 – REVISED MAY 1997

## logic diagram (positive logic)



Pin numbers shown are for the PN package.

# SN54ABTH32318, SN74ABTH32318 18-BIT TRI-PORT UNIVERSAL BUS EXCHANGERS

SCBS180E – JUNE 1992 – REVISED MAY 1997

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage range, $V_{CC}$ .....	–0.5 V to 7 V
Input voltage range, $V_I$ (except I/O ports) (see Note 1) .....	–0.5 V to 7 V
Voltage range applied to any output in the high or power-off state, $V_O$ .....	–0.5 V to 5.5 V
Current into any output in the low state, $I_O$ : SN54ABTH32318 .....	96 mA
SN74ABTH32318 .....	128 mA
Input clamp current, $I_{IK}$ ( $V_I < 0$ ) .....	–18 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ ) .....	–50 mA
Package thermal impedance, $\theta_{JA}$ (see Note 2): PN package .....	62°C/W
Storage temperature range, $T_{stg}$ .....	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.  
2. The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51.

## recommended operating conditions (see Note 3)

		SN54ABTH32318		SN74ABTH32318		UNIT
		MIN	MAX	MIN	MAX	
$V_{CC}$	Supply voltage	4.5	5.5	4.5	5.5	V
$V_{IH}$	High-level input voltage	2		2		V
$V_{IL}$	Low-level input voltage		0.8		0.8	V
$V_I$	Input voltage	0	$V_{CC}$	0	$V_{CC}$	V
$I_{OH}$	High-level output current		–24		–32	mA
$I_{OL}$	Low-level output current		48		64	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	Outputs enabled		10	10	ns/V
$\Delta t/\Delta V_{CC}$	Power-up ramp rate	200		200		μs/V
$T_A$	Operating free-air temperature	–55	125	–40	85	°C

NOTE 3: Unused control pins must be held high or low to prevent them from floating.

# SN54ABTH32318, SN74ABTH32318 18-BIT TRI-PORT UNIVERSAL BUS EXCHANGERS

SCBS180E – JUNE 1992 – REVISED MAY 1997

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER		TEST CONDITIONS	SN54ABTH32318			SN74ABTH32318			UNIT	
			MIN	TYP†	MAX	MIN	TYP†	MAX		
V <sub>IK</sub>		V <sub>CC</sub> = 4.5 V, I <sub>I</sub> = -18 mA			-1.2			-1.2	V	
V <sub>OH</sub>		V <sub>CC</sub> = 4.5 V, I <sub>OH</sub> = -3 mA	2.5			2.5			V	
		V <sub>CC</sub> = 5 V, I <sub>OH</sub> = -3 mA	3			3				
		V <sub>CC</sub> = 4.5 V, I <sub>OH</sub> = -24 mA	2					2		
V <sub>OL</sub>		V <sub>CC</sub> = 4.5 V, I <sub>OL</sub> = 48 mA			0.55			0.55	V	
		V <sub>CC</sub> = 4.5 V, I <sub>OL</sub> = 64 mA			0.55			0.55		
V <sub>hys</sub>				100			100	mV		
I <sub>I</sub>	Control inputs	V <sub>CC</sub> = 0 to 5.5 V, V <sub>I</sub> = V <sub>CC</sub> or GND			±1			±1	µA	
	A, B, or C ports	V <sub>CC</sub> = 2.1 V to 5.5 V, V <sub>I</sub> = V <sub>CC</sub> or GND			±20			±20		
I <sub>I</sub> (hold)	A, B, or C ports	V <sub>CC</sub> = 4.5 V, V <sub>I</sub> = 0.8 V	100			100			µA	
		V <sub>CC</sub> = 4.5 V, V <sub>I</sub> = 2 V	-100			-100				
I <sub>OZPU</sub> ‡		V <sub>CC</sub> = 0 to 2.1 V, V <sub>O</sub> = 0.5 V to 2.7 V, $\overline{OE}$ = X			±50			±50	µA	
I <sub>OZPD</sub> ‡		V <sub>CC</sub> = 2.1 V to 0, V <sub>O</sub> = 0.5 V to 2.7 V, $\overline{OE}$ = X			±50			±50	µA	
I <sub>off</sub>		V <sub>CC</sub> = 0, V <sub>I</sub> or V <sub>O</sub> ≤ 4.5 V			±100			±100	µA	
I <sub>CEX</sub>		V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 5.5 V, Outputs high			50			50	µA	
I <sub>O</sub> §		V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 2.5 V	-50	-100	-180	-50	-100	-180	mA	
I <sub>CC</sub>		V <sub>CC</sub> = 5.5 V, I <sub>O</sub> = 0, V <sub>I</sub> = V <sub>CC</sub> or GND	Outputs high			2	2			mA
			Outputs low			45	45			
			Outputs disabled			1	1			
ΔI <sub>CC</sub> ¶		V <sub>CC</sub> = 5.5 V, One input at 3.4 V, Other inputs at V <sub>CC</sub> or GND			0.5			0.5	mA	
C <sub>i</sub>	Control inputs	V <sub>I</sub> = 2.5 V or 0.5 V			3			3	pF	
C <sub>io</sub>	A, B, or C ports	V <sub>O</sub> = 2.5 V or 0.5 V			11.5			11.5	pF	

† All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

‡ This parameter is specified by characterization.

§ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

¶ This is the increase in supply current for each input that is at the specified TTL voltage level rather than V<sub>CC</sub> or GND.

**timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)**

		SN54ABTH32318		SN74ABTH32318		UNIT
		MIN	MAX	MIN	MAX	
f <sub>clock</sub>	Clock frequency		150		150	MHz
t <sub>w</sub>	Pulse duration	LE high	3.3		3.3	ns
		CLK high or low	3.3		3.3	
t <sub>su</sub>	Setup time	A, B, or C before CLK↑	2.4		2.4	ns
		A, B, or C before LE↓	2.1		2.1	
t <sub>h</sub>	Hold time	A, B, or C after CLK↑	1.4		1.4	ns
		A, B, or C after LE↓	2.1		2.1	

# SN54ABTH32318, SN74ABTH32318 18-BIT TRI-PORT UNIVERSAL BUS EXCHANGERS

SCBS180E – JUNE 1992 – REVISED MAY 1997

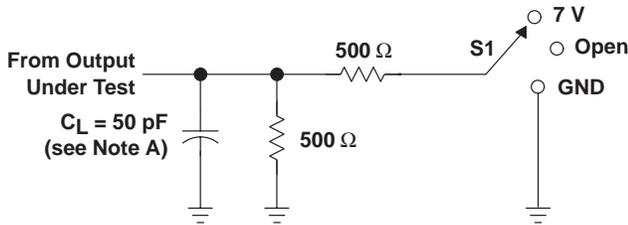
switching characteristics over recommended ranges of supply voltage and operating free-air temperature,  $C_L = 50$  pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54ABTH32318		SN74ABTH32318		UNIT
			MIN	MAX	MIN	MAX	
$f_{max}$			150		150		MHz
$t_{PLH}$	A, B, or C	C, B, or A	1.4	6.5	1.4	6.1	ns
$t_{PHL}$			1.1	6.8	1.1	6.6	
$t_{PLH}$	SEL	A, B, or C	1.4	6.7	1.4	6.5	ns
$t_{PHL}$			1.8	6.8	1.8	6.5	
$t_{PLH}$	LE	A, B, or C	2.6	8	2.6	7.5	ns
$t_{PHL}$			2.6	7.4	2.6	6.9	
$t_{PLH}$	CLK	A, B, or C	2.5	8	2.5	7.4	ns
$t_{PHL}$			2.5	7.2	2.5	6.7	
$t_{PZH}$	$\overline{OE}$	A, B, or C	1.4	6.9	1.4	6.8	ns
$t_{PZL}$			2.4	7.2	2.4	7.1	
$t_{PHZ}$	$\overline{OE}$	A, B, or C	1	6.4	1	6.2	ns
$t_{PLZ}$			2	6.4	2	6	

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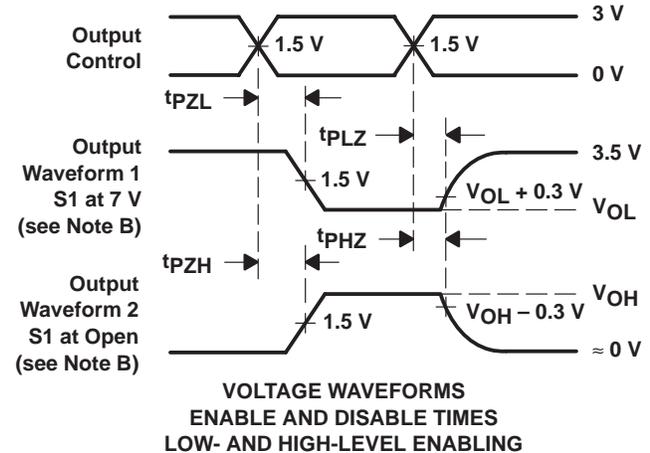
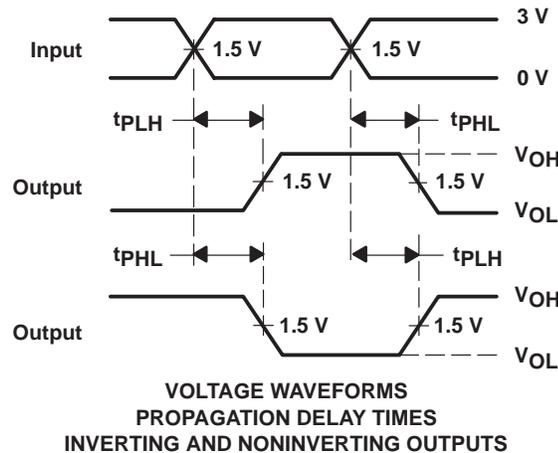
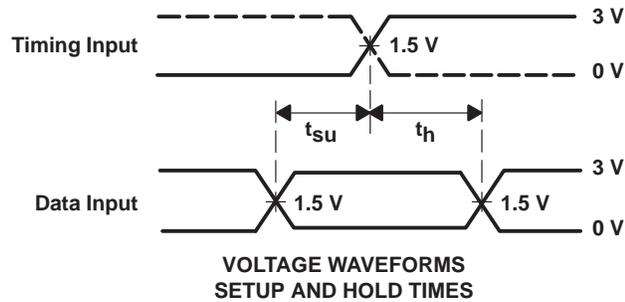
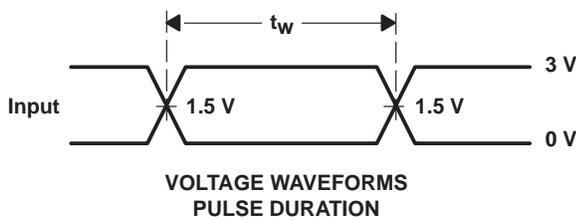
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## PARAMETER MEASUREMENT INFORMATION



LOAD CIRCUIT

TEST	S1
$t_{PLH}/t_{PHL}$	Open
$t_{PLZ}/t_{PZL}$	7 V
$t_{PHZ}/t_{PZH}$	Open



- NOTES:
- $C_L$  includes probe and jig capacitance.
  - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5 \text{ ns}$ ,  $t_f \leq 2.5 \text{ ns}$ .
  - The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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